OPE5587

The **OPE5587** is GaAlAs infrared emitting diode that is designed for high power, low forward voltage and high speed rise / fall time. This device is optimized for speed and efficiency at emission wavelength 880nm and has a high radiant efficiency over a wide range of forward current. This device is packaged T1-3/4 package and has narrow beam angle with lensed package and cup frame. Especially this device is suited as the emitter of data transmission without cable.

FEATURES

- Ultra high-speed: 25ns rise time
- 880nm wavelength
- Narrow beam angle
- Low forward voltage
- High power and high reliability
- Available for pulse operating

APPLICATIONS

- Emitter of IrDA
- IR Audio and Telephone
- High speed IR communication
- IR LANs
- Available for wireless digital data transmission

STORAGE

- Condition : 5°C~35°C,R.H.60%
- Terms: within 3 months from production date
- Remark : Once the package is opened, the products should be used within a day. Otherwise, it should be keeping in a damp proof box with desiccants.
- * Please take proper steps in order to secure reliability and safety in required conditions and environments for this device.

MAXIMUM RATINGS

(\mathbf{T}_{α})	-259	00	١
(Ia	=23	\mathbf{C})

DIMENSIONS (Unit:mm)

2- \square 0.5

1 Cathode

② Anode

Tolerance: ±0.2mm

Item	Symbol	Rating	Unit
Power dissipation	P_{D}	150	mW
Forward current	I_{F}	100	mA
Pulse forward current *1	I_{FP}	1.0	A
Reverse voltage	V_R	4.0	V
Operating temp.	$T_{ m opr.}$	-25~+85	°C
Soldering temp. *2	$T_{sol.}$	260	°C

^{*1.} Duty ratio = 1/100, pulse width=0.1ms.

ELECTRO-OPTICALCHARACTERISTICS

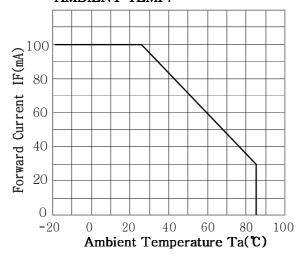
 $(Ta=25^{\circ}C)$

Item	Symbol	Conditions	Min.	Typ.	Max.	Unit
Forward voltage	V_{F}	I _F =50mA		1.5	2.0	V
Reverse current	I_R	$V_R=4V$			10	μA
Capacitance	Ct	f=1MHz		20		pF
Radiant intensity	Ie	I _F =50mA	40	90		mW/sr
Peak emission wavelength	$\lambda_{ m p}$	I _F =50mA		880		nm
Spectral bandwidth 50%	Δλ	I _F =50mA		45		nm
Half angle	$\Delta \theta$	$I_F=50mA$		±10		deg.
Optical rise & fall time(10%~90%)	tr/tf	$I_F=50mA$		25/15		ns
Cut off frequency *3	fc	I _F =50mA DC +10mA p-p		14		MHz

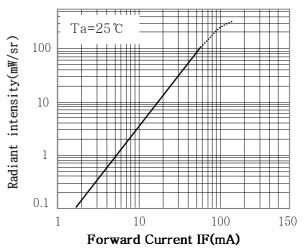
^{*3. 10}logPo(fc MHz)/Po(0.1 MHz)=-3

^{*2.}Lead Soldering Temperature (2mm from case for 5sec.).

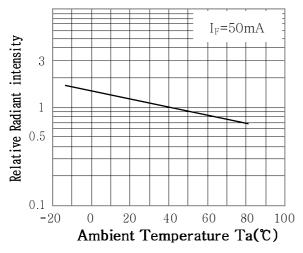
• FORWARD CURRENT Vs. AMBIENT TEMP.



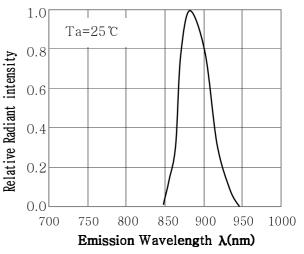
 RADIANT INTENSITY Vs. FORWARD CURRENT.



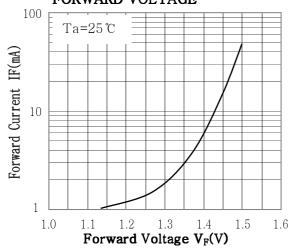
• RELATIVE RADIANT INTENSITY Vs. AMBIENT TEMP.



• RELATIVE RADIANT INTENSITY Vs. EMISSION WAVELENGTH.



FORWARD CURRENT Vs.
 FORWARD VOLTAGE



 ANGULAR DISPLACEMENT Vs RELATIVE RADIANT INTENSITY

